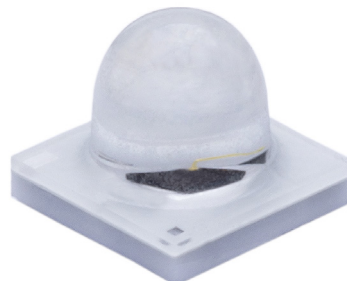


# SST-05-IR-B40

## Surface Mount Series

## Infrared LED



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### Features

- High Power Infrared LED with typical 850nm wavelength
- 20 degree half-angle dome for high-irradiance and simpler optical design for directional applications
- Operation at up to 1A pulsed
- Built-in ESD protection
- Low Thermal Resistance
- Suitable for all SMT Assembly Methods
- RoHS and REACH compliant

### Applications

- Surveillance Systems / CCTV
- Iris and Face Recognition
- License Plate Scanning
- Automotive Sensing
- Machine Vision
- Night Vision
- Replacement of legacy 5mm IR LEDs for improved designs

## Technology Overview

Luminus SST-05-IR-B40 LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

### Reliability

Luminus SST-05-IR-B40 LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity. They are fully qualified for use in a wide range of high performance and high efficacy applications.

### REACH & RoHS Compliance

The Luminus SST-05-IR-B40 LED is compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used.

## Understanding Luminus SST-05-IR-B40 LED Test Specifications

Every Luminus LED is fully tested to ensure it meets the high quality standards customers have come to expect from Luminus products.

### Testing Temperature

Luminus SST-05-IR-B40 LEDs are tested and binned at 25°C junction temperature. Temperature curves are provided to allow users to scale the data for actual operating temperature conditions.

## Product Ordering and Shipping Part Number Nomenclature

All SST-05-IR-B40 products are packaged and labeled with part numbers as outlined in below. When shipped, each reel will contain only a single flux wavelength and Vf bin. The part number designation is as follows:

| Products      | Ordering Part Number | Description                       |
|---------------|----------------------|-----------------------------------|
| SST-05-IR-B40 | SST-05-IR-B40-F###   | SST-05 surface mount infrared LED |

**SST** — **05** — **CC** — **B40** — **F###**

| Product Family                                       | Chip Area               | Color         | Package Configuration                                                                     | Bin Kit <sup>1,2</sup>                                |
|------------------------------------------------------|-------------------------|---------------|-------------------------------------------------------------------------------------------|-------------------------------------------------------|
| SST - Ceramic Surface Mount package w/ encapsulation | 05: 0.5 mm <sup>2</sup> | IR = Infrared | B40 - 40 deg Beam Angle<br>Ceramic 3.45mm x 3.45mm<br>See Pages 6-7 for Detailed Drawings | See below for flux and wavelength binning information |

| Peak Wavelength | Minimum Flux Bin (mW) | Lens Angle | Ordering Part Number      |
|-----------------|-----------------------|------------|---------------------------|
| 850             | 235                   | 40         | <i>SST-05-IR-B40-J850</i> |

### Flux Bins<sup>1</sup>

| Bin Code | Radiometric Power at 350mA, t <sub>p</sub> =20ms |                   | Correlated radiant intensity at 1.0A, t <sub>p</sub> =20ms |                                |
|----------|--------------------------------------------------|-------------------|------------------------------------------------------------|--------------------------------|
|          | Minimum Flux (mW)                                | Maximum Flux (mW) | Min. Radiant Intensity (mW/sr)                             | Max. Radiant Intensity (mW/sr) |
| J        | 235                                              | 265               | 697                                                        | 786                            |
| K        | 265                                              | 295               | 786                                                        | 875                            |
| L        | 295                                              | 325               | 875                                                        | 964                            |
| M        | 325                                              | 355               | 964                                                        | 1053                           |

### Wavelength Bins<sup>1</sup>

| Bin Code | Minimum Peak Wavelength (nm) | Maximum Peak Wavelength (nm) |
|----------|------------------------------|------------------------------|
| 850      | 840                          | 870                          |

## Optical and Electrical Characteristics

### Optical and Electrical Characteristics<sup>1</sup>

| Parameter                                    | Symbol                | Package Type | Unit  |
|----------------------------------------------|-----------------------|--------------|-------|
|                                              |                       | B40-850      |       |
| Forward Current                              | $I_f$                 | 350          | mA    |
| Output Power Typical                         | $PO$                  | 295          | mW    |
| Output Power at 1.0A, $t_r=20ms$ (typ.)      | $PO_{1.0A}$           | 800          | mW    |
| Radiant Intensity at 1.0A, $t_r=20ms$ (typ.) | $\phi_e$              | 875          | mW/sr |
| Minimum Forward Voltage <sup>1</sup>         | $V_{fmin}$            | 1.2          | V     |
| Forward Voltage Typical                      | $V_f$                 | 1.6          | V     |
| Maximum Forward Voltage <sup>1</sup>         | $V_{fmax}$            | 2.0          | V     |
| Viewing Angle                                | $2\theta_{1/2}$       | 40           | deg   |
| Peak Wavelength Typical                      | $\lambda_p$           | 850          | nm    |
| Centroid Wavelength Typical                  | $\lambda_c$           | 860          | nm    |
| FWHM Typical                                 | $\Delta\lambda_{1/2}$ | 30           | nm    |
| Temperature Coefficient of Forward voltage   | $TC_{V_f}$            | -1.5         | mV/°C |
| Temperature Coefficient of Radiometric Power | $TC_{PO}$             | -0.3         | %/°C  |
| Temperature Coefficient of Wavelength        | $TC_{\lambda}$        | 0.3          | nm/°C |
| Thermal Resistance (Electrical)              | $R_{TH}$              | 9.2          | °C/W  |

Note 1: Binning based on operation at a current of 350mA, 20ms single pulse and a constant junction temperature of  $T_j = 25^\circ\text{C}$ . Parts are binned and shipped in 0.2V Vf increments.

## Optical and Electrical Characteristics

### Absolute Maximum Ratings<sup>2</sup>

| Parameter                           | Symbol           | Rating             | Unit |
|-------------------------------------|------------------|--------------------|------|
| Forward Current <sup>3,4</sup>      | I                | 1.0                | A    |
| Power Dissipation                   | P <sub>D</sub>   | 2.5                | W    |
| Reverse Voltage                     | V <sub>R</sub>   | 5                  | V    |
| Storage Temperature                 | T <sub>STG</sub> | -40~100            | °C   |
| Junction Temperature <sup>3,4</sup> | T <sub>J</sub>   | 115 °C             | °C   |
| Soldering Temperature               | T <sub>SLD</sub> | JEDEC 020 , 260 °C |      |
| ESD Sensitivity (HBM)               | V <sub>B</sub>   | 6000               | V    |
|                                     |                  |                    |      |

*Note 2: To prevent damage refer to operating conditions and derating curves for appropriate maximum operating conditions*

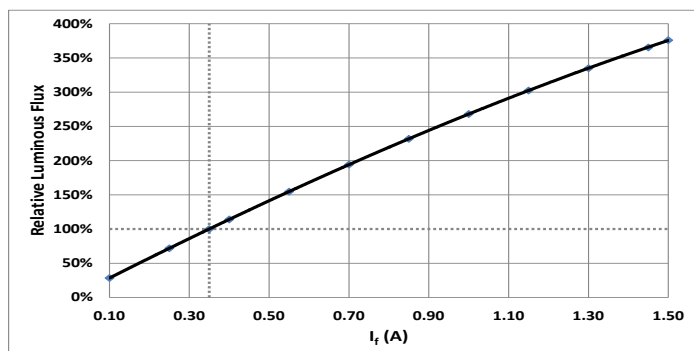
*Note 3: Luminus SST-05-IR-B40 LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.*

*Note 4: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please operate devices within specified conditions.*

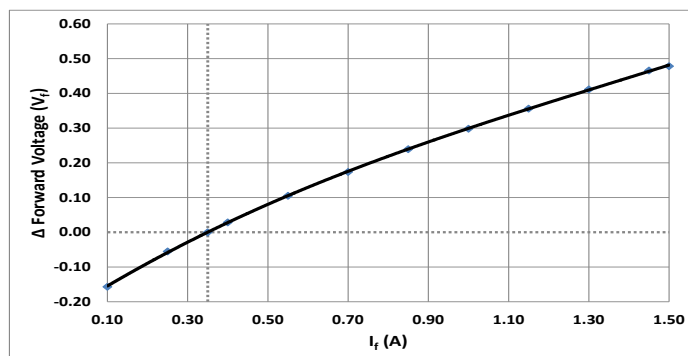
*Note 5: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.*

## Optical and Electrical Characteristics

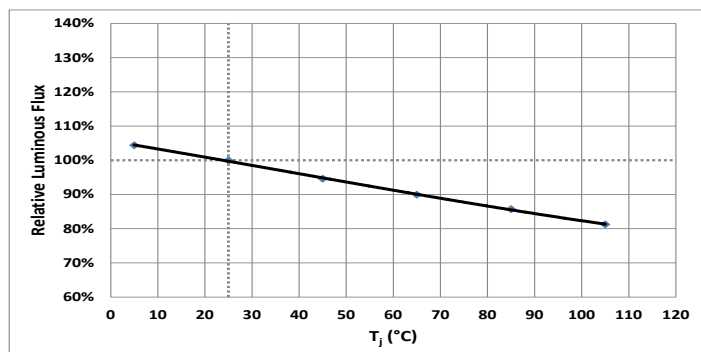
**Relative Output Flux vs. Forward Current**



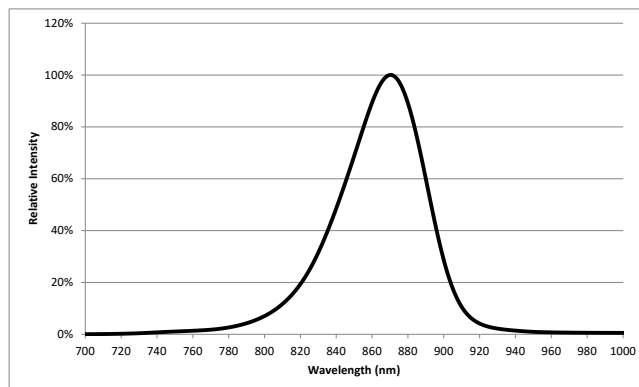
**Relative Voltage vs Forward Current**



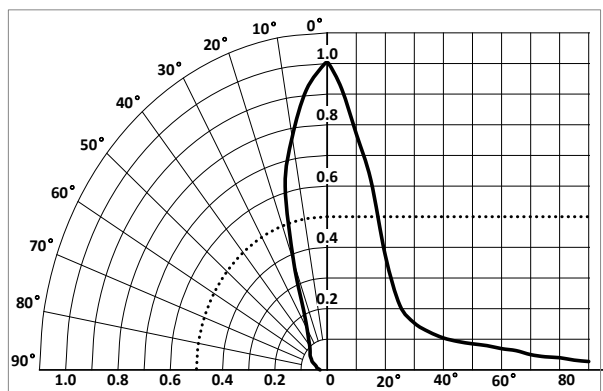
**Relative Output Flux vs. Temperature**



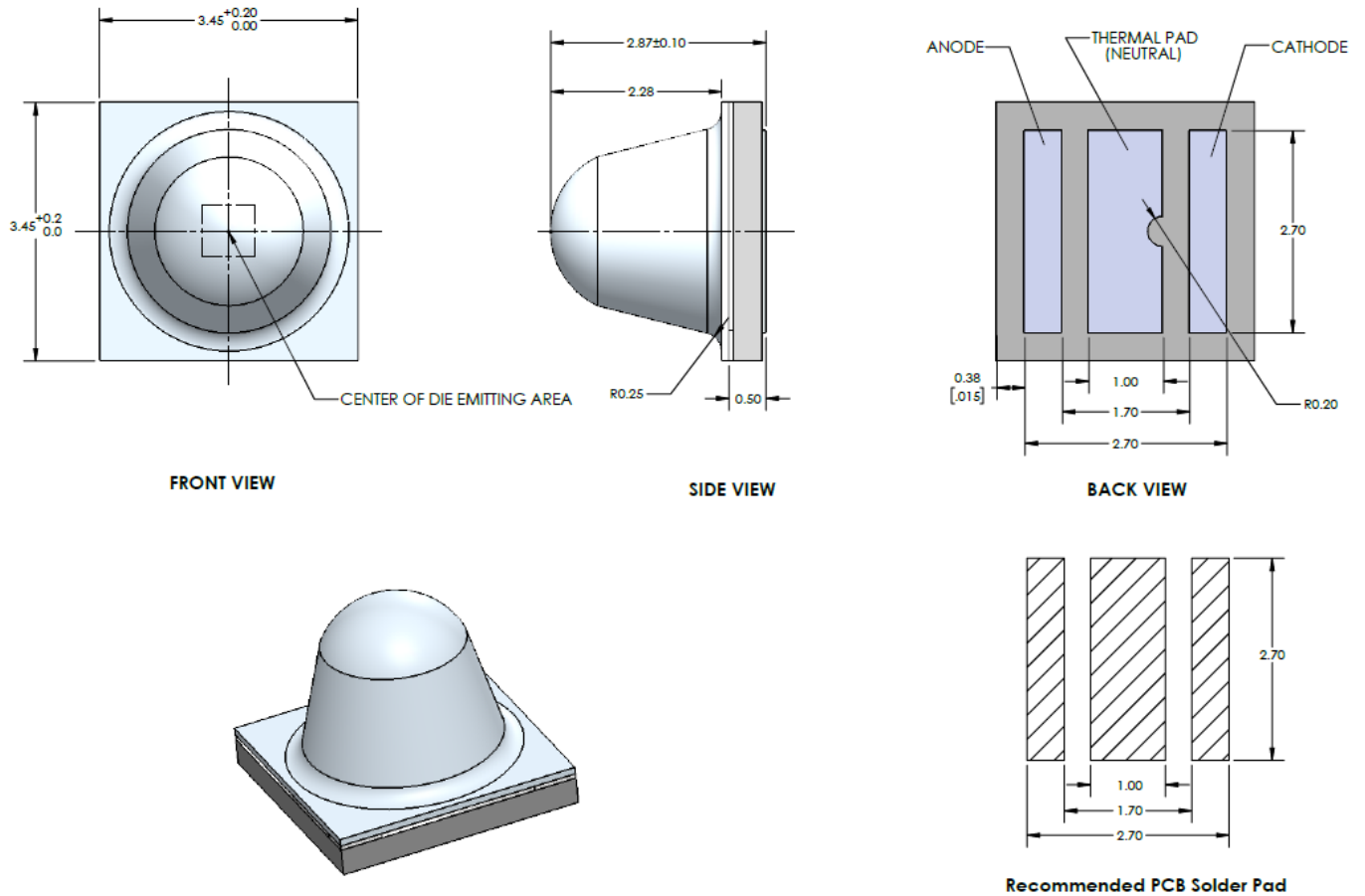
**Typical Spectra**



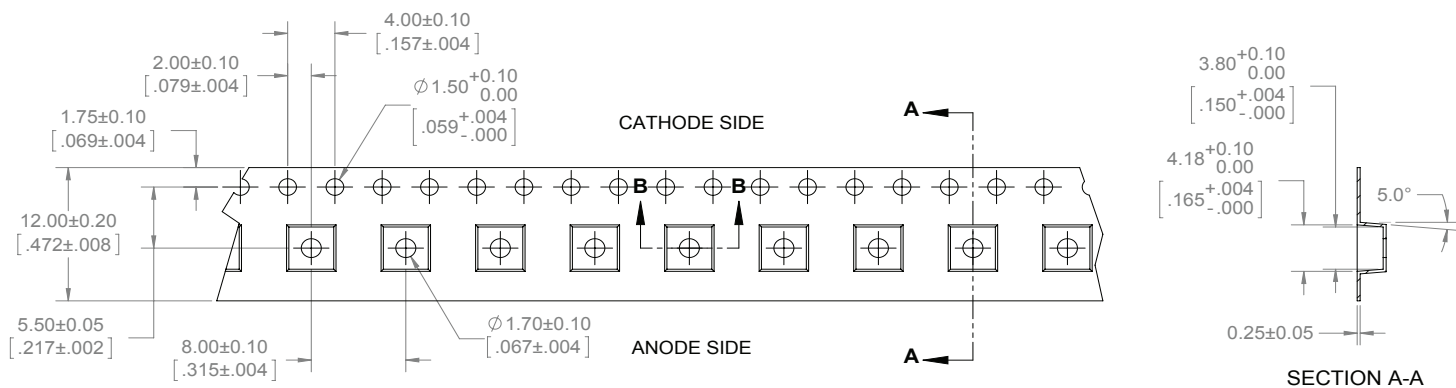
**Typical Polar Radiation Plot - B40**



## Mechanical Dimensions - B40 Package

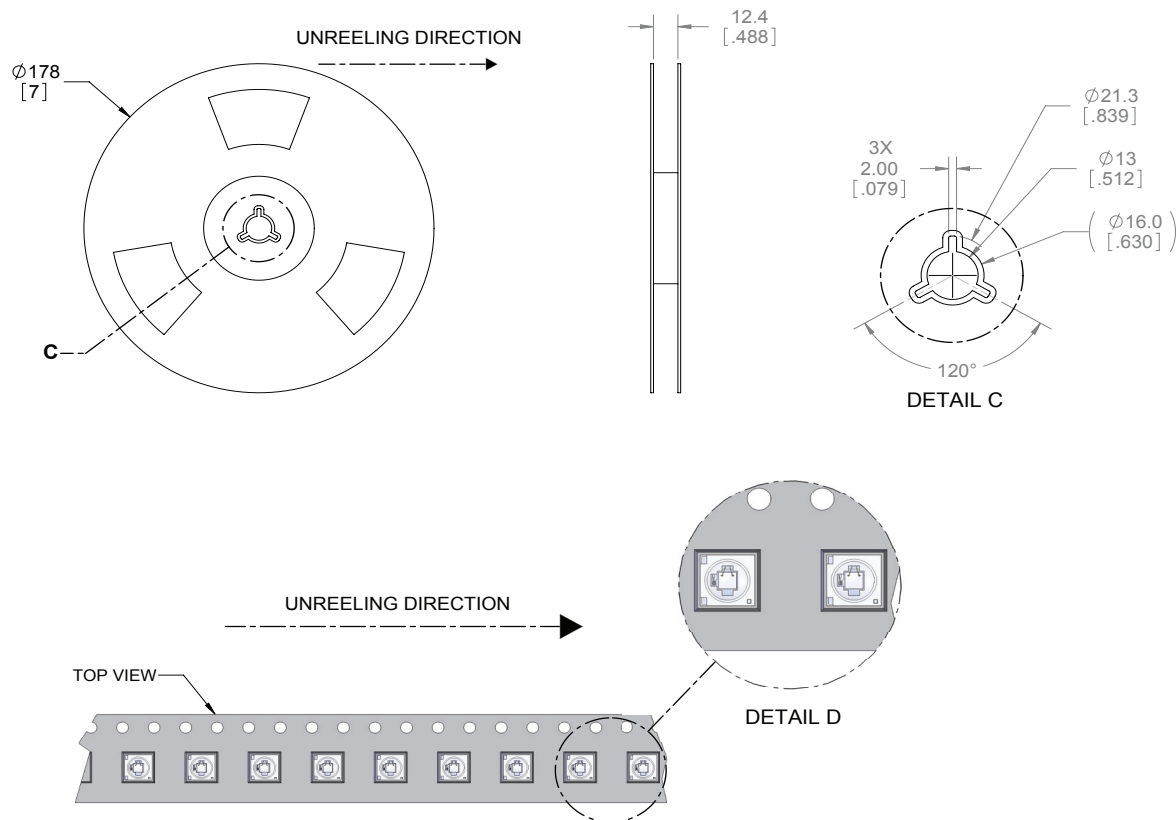


## Tape and Reel - B40 Package

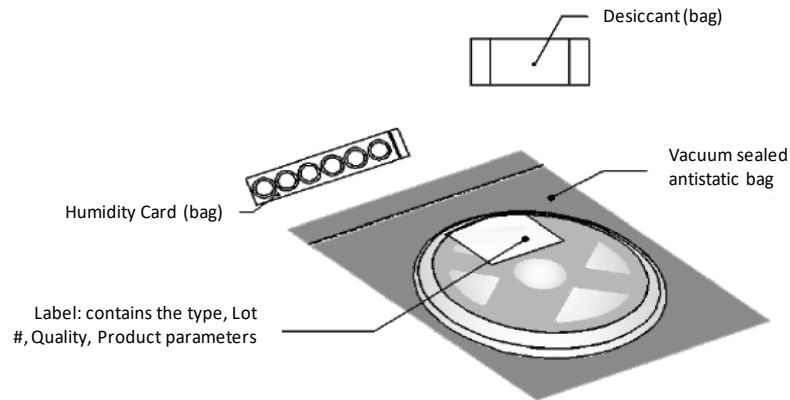


### NOTES:

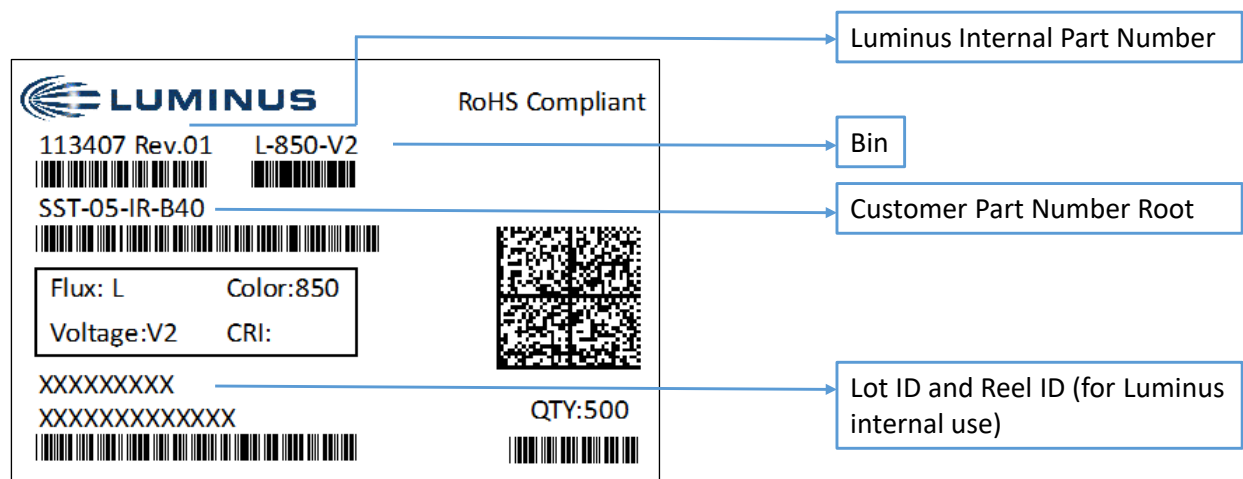
1. FINAL TAPE AND REEL PACKAGING MUST MEET THE REQUIREMENTS OF JEDEC-STD-033, LEVEL 2A.
2. LEAVE 304.8mm [12.00 in] OF TAPE EMPTY FOR LEAD IN (38 EMPTY POCKETS).
3. LEAVE 457.2mm [18.00 in] OF TAPE EMPTY FOR TRAILER (57 EMPTY POCKETS).
4. MUST COMPLY TO EIA-481-C-2003



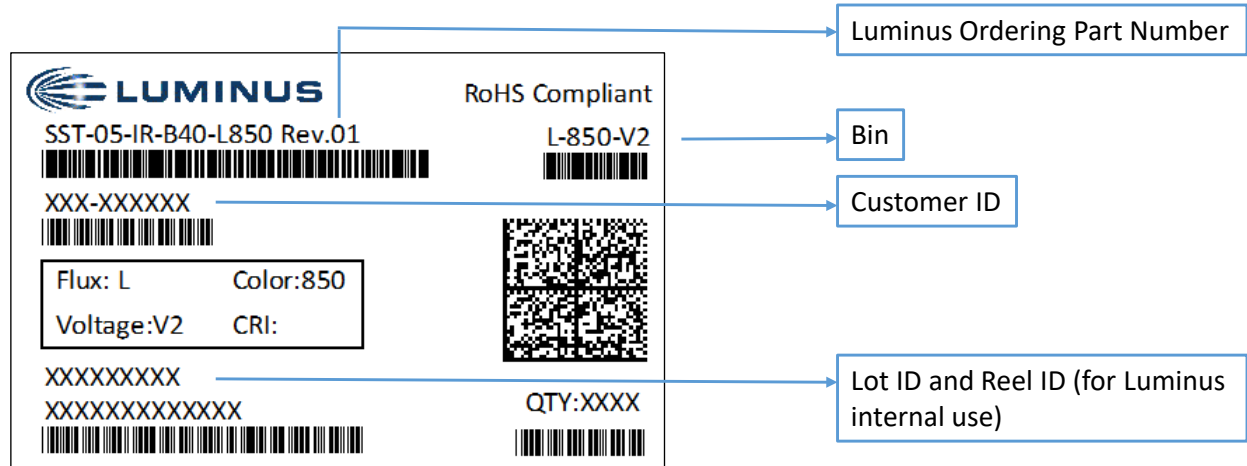
## Reel Packaging (500 parts per reel)



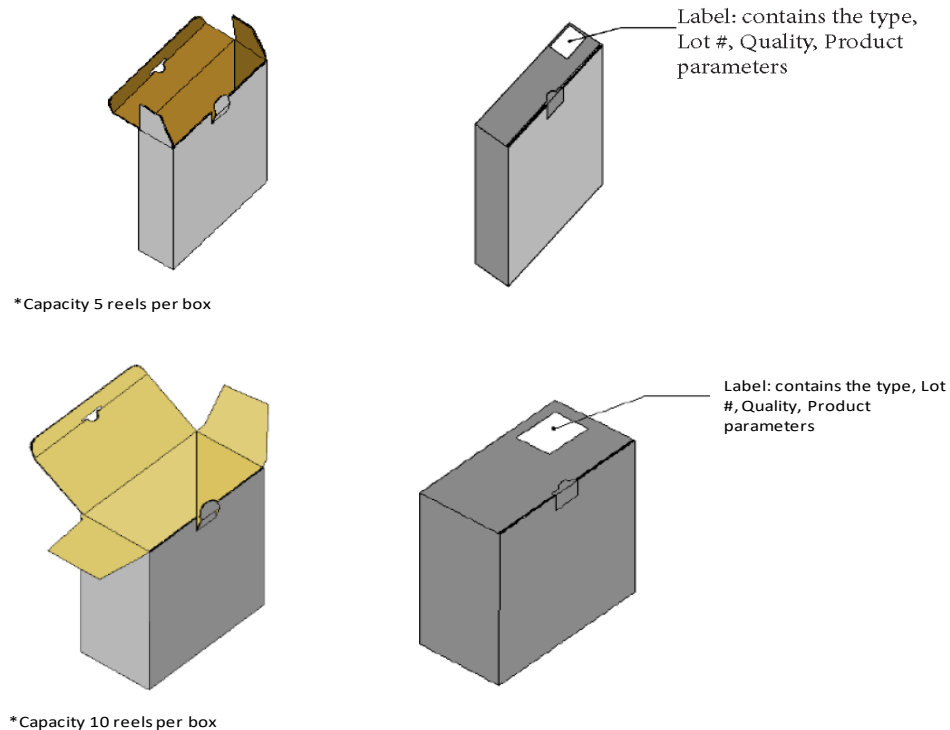
## Reel Label



### Shipping Label



### Box Packaging Information

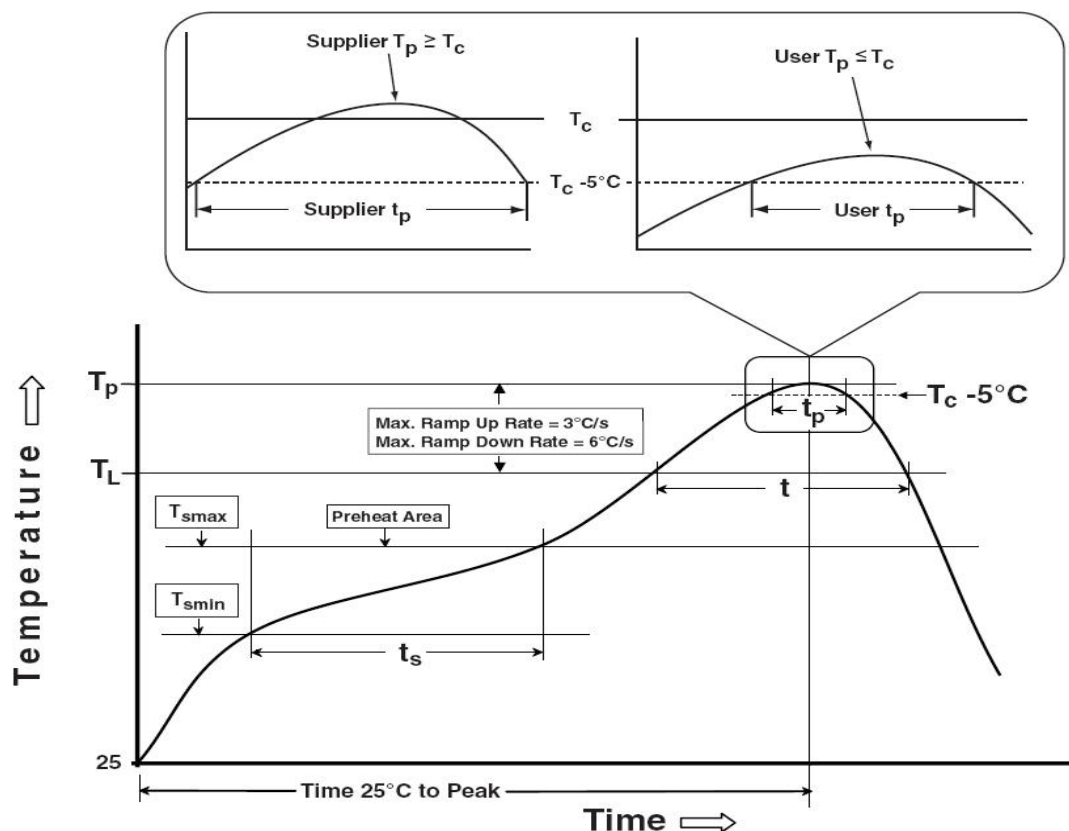


## Soldering Profile

| Profile Feature                                                                                  | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--------------------------------------------------------------------------------------------------|-------------------------|------------------|
| Preheat & Soak                                                                                   | 100 °C                  | 150 °C           |
| Temperature min (T <sub>min</sub> )                                                              | 150 °C                  | 200 °C           |
| Temperature max (T <sub>max</sub> )                                                              | 60-120 seconds          | 60-120 seconds   |
| Time (T <sub>min</sub> to T <sub>max</sub> ) (t <sub>s</sub> )                                   |                         |                  |
| Average ramp-up rate (T <sub>max</sub> to T <sub>p</sub> )                                       | 3 °C/second max         | 3 °C/second max  |
| Liquidous temperature (T <sub>L</sub> )                                                          | 183 °C                  | 217 °C           |
| Time at liquidous (t <sub>L</sub> )                                                              | 60-150 seconds          | 60-150 seconds   |
| Peak package body temperature (T <sub>p</sub> )*                                                 | 230 °C ~235 °C          | 255 °C ~260 °C   |
| Classification temperature (T <sub>c</sub> )                                                     | 235 °C                  | 260 °C           |
| Time (t <sub>p</sub> ) within 5 °C of the specified classification temperature (T <sub>c</sub> ) | 20 seconds              | 30 seconds       |
| Average ramp-down rate (T <sub>p</sub> to T <sub>max</sub> )                                     | 6 °C/second max         | 6 °C/second max  |
| Time 25 °C to peak temperature                                                                   | 6 minutes max           | 8 minutes max    |

\* Tolerance for peak profile temperature(T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature(t<sub>p</sub>) is defined as a supplier minimum and a user maximum.



## Precautions for Use

### Storage:

#### 1. Before opening the package

The LEDs should be kept at  $<40^{\circ}\text{C}$  &  $<90\%\text{RH}$ . The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

#### 2. After opening the package

The LEDs should be kept at  $\leq 30^{\circ}\text{C}$  &  $\leq 60\%\text{RH}$ . The LEDs should be soldered within 168 hours (7days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions :  $60^{\circ}\text{C}$  for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

### Static Electricity:

1. The products are sensitive to static electricity, and care should be taken when handling them.

2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear a anti-electrostatic wristband or an anti-electrostatic gloves when handling the LEDs.

3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

## History of Changes

| Rev | Date       | Description of Change |
|-----|------------|-----------------------|
| 01  | 10/15/2018 | Initial Release       |

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